

**VDIC
MAGNETORESISTIVES
RANDOM ACCESS
MEMORY**

**VDMR16M08XS44XX1V35
USER MANUAL**

Version : A2

Document NO. : ORBITA/SIP- VDMR16M08XS44XX1V35 -USM-01

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VDIC-MRAM

HIGH-SPEED 3.3V 2M × 8bit

MAGNETORESISTIVES RANDOM ACCESS MEMORY

1 DESCRIPTION

The VDMR16M08XS44XX1V35 is a 1 x 16,777,216-bit Magnetoresistive Random Access Memory device. Manufactured with VDIC Very Dense SiP technology, this device stacks 16-Mbit MRAM dies. It is organized as one independent die of 2M x 8bit wide data interface.

The VDMR16M08XS44XX1V35 offers SRAM compatible 35ns read/write timing with unlimited endurance. Data is always non-volatile for greater than 20-years. Data is automatically protected on power loss by low-voltage inhibit circuitry to prevent writes with voltage out of specification. The VDMR16M08XS44XX1V35 is the ideal memory solution for applications that must permanently store and retrieve critical data and programs quickly.

The VDMR16M08XS44XX1V35 has one die. It can be selected with dedicated #E. Low interconnect parasitic capacitance of the stacking technology, by reducing the connection length, allows this MRAM module to be useful for a variety of high bandwidth, high performance and high density memory system applications.

2 FEATURES

- Fast 35ns Read/Write Cycle
- SRAM Compatible Timing, Uses Existing SRAM Controllers Without Redesign
- Unlimited Read & Write Endurance
- Data Always Non-volatile for >20-years
- One Memory Replaces Flash, SRAM, EEPROM and BBSRAM in a system for simpler, more efficient design
- Stack of one 16Mbit MRAM
- Organized as 1 die of 2M x 8 bit memory
- One independent Ship Select
- 3.3 Volt Power Supply
- Automatic Data Protection on Power Loss
- 44-lead SOP package

3 BLOCK DIAGRAM

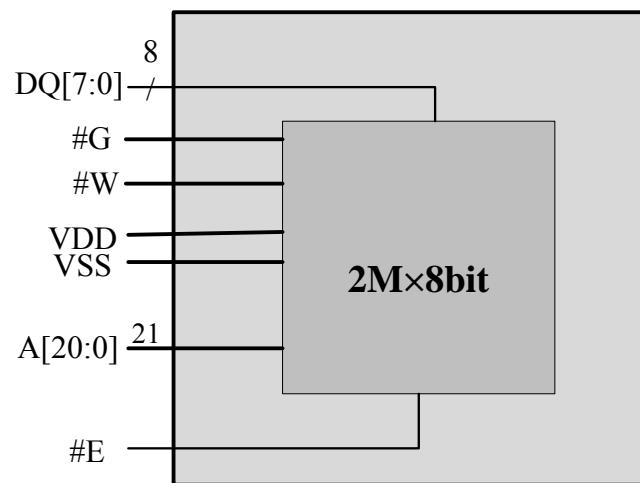


Figure 1 Block diagram

4 PIN DESCRIPTIONS

| Pin Id | Pin # | | Pin Id |
|--------|-------|--|--------|
| DC | 1 | | DC |
| A20 | 2 | | A19 |
| A0 | 3 | | DC |
| A1 | 4 | | A18 |
| A2 | 5 | | A17 |
| A3 | 6 | | A16 |
| A4 | 7 | | A15 |
| #E | 8 | | #G |
| DQ0 | 9 | | DQ7 |
| DQ1 | 10 | | DQ6 |
| VDD | 11 | | VSS |
| VSS | 12 | | VDD |
| DQ2 | 13 | | DQ5 |
| DQ3 | 14 | | DQ4 |
| #W | 15 | | DC |
| A5 | 16 | | A14 |
| A6 | 17 | | A13 |
| A7 | 18 | | A12 |
| A8 | 19 | | A11 |
| A9 | 20 | | A10 |
| DC | 21 | | DC |
| DC | 22 | | DC |

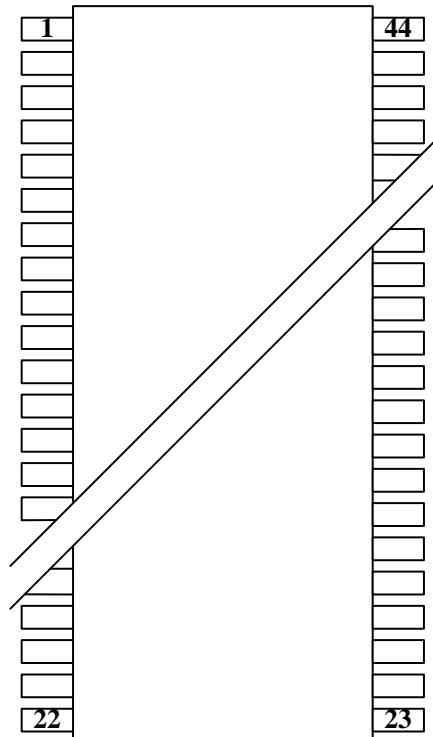


Figure 2 Pin configuration

Table 1 Pin description

| Pin | Name | Function |
|------------|---------------------|---|
| #E | Chip Enable | Disables or enables memory operation |
| A0 ~ A20 | Address | 21-bit addresses |
| #W | Write enable | Enables write operation common to all memory dies |
| #G | Output enable | Enables data output common to all memory dies |
| DQ0~ DQ7 | Data input/output | Data inputs/outputs 8-bit wide bus |
| VDD/VSS | Power supply/ground | Power and ground for the input/output buffers and core logic. |
| DC | Do not connect | These pins do not connect |

5 ELECTRICAL SPECIFICATIONS

5.1 ABSOLUTE MAXIMUM RATINGS

This device contains circuitry to protect the inputs against damage caused by high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage greater than maximum rated voltages to these high-impedance (Hi-Z) circuits.

The device also contains protection against external magnetic fields. Precautions should be taken to avoid application of any magnetic field more intense than the maximum field intensity specified in the maximum ratings.

Table 2 Absolute maximum ratings

| Characteristics | Symbol | Maximum ratings | Unit |
|---------------------------------------|---------------|------------------------|-------------|
| Voltage on VDD supply relative to Vss | VDD | -0.5 ~ +4.0 | V |
| Voltage on any pin relative to Vss | VIN | -0.5 ~ VDD +0.5 | V |
| Power Dissipation | PD | < 0.6 | W |
| Operating Temperature Range | TOPR | -55 ~ +95 | °C |
| Storage Temperature Range | TSTG | -55 ~ +105 | °C |

5.2 RECOMMENDED DC OPERATING CONDITIONS

Table 3 Recommended DC operating condition

| Parameter | Symbol | Min | Typ | Max | Unit |
|-----------------------|-----------------|------|-----|----------------------|------|
| Supply voltage | V _{DD} | 3.0 | 3.3 | 3.6 | V |
| Input high voltage | V _{IH} | 2.2 | — | V _{DD} +0.3 | V |
| Input low voltage | V _{IL} | -0.5 | — | 0.8 | V |
| Write inhibit voltage | V _{WI} | 2.5 | 2.7 | 3.0 | V |

5.3 DC CHARACTERISTICS

Table 4 DC characteristics

| Parameter | Symbol | Test Conditions | Min | Max | Unit |
|---------------------------|-----------------|------------------------|-----|-----|------|
| Output voltage low level | V _{OL} | I _{OL} = +4mA | — | 0.4 | V |
| Output voltage high level | V _{OH} | I _{OL} = -4mA | 2.4 | — | V |

6 TYPICAL APPLICATION

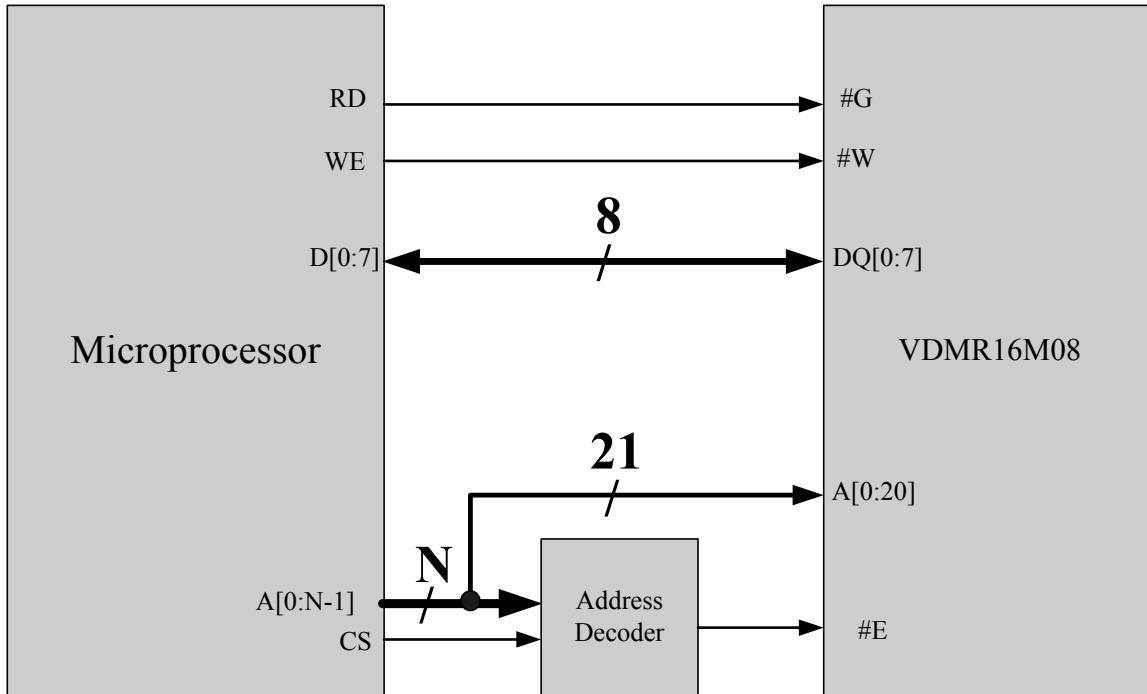


Figure 3 Typical application

7 ORDERING INFORMATION

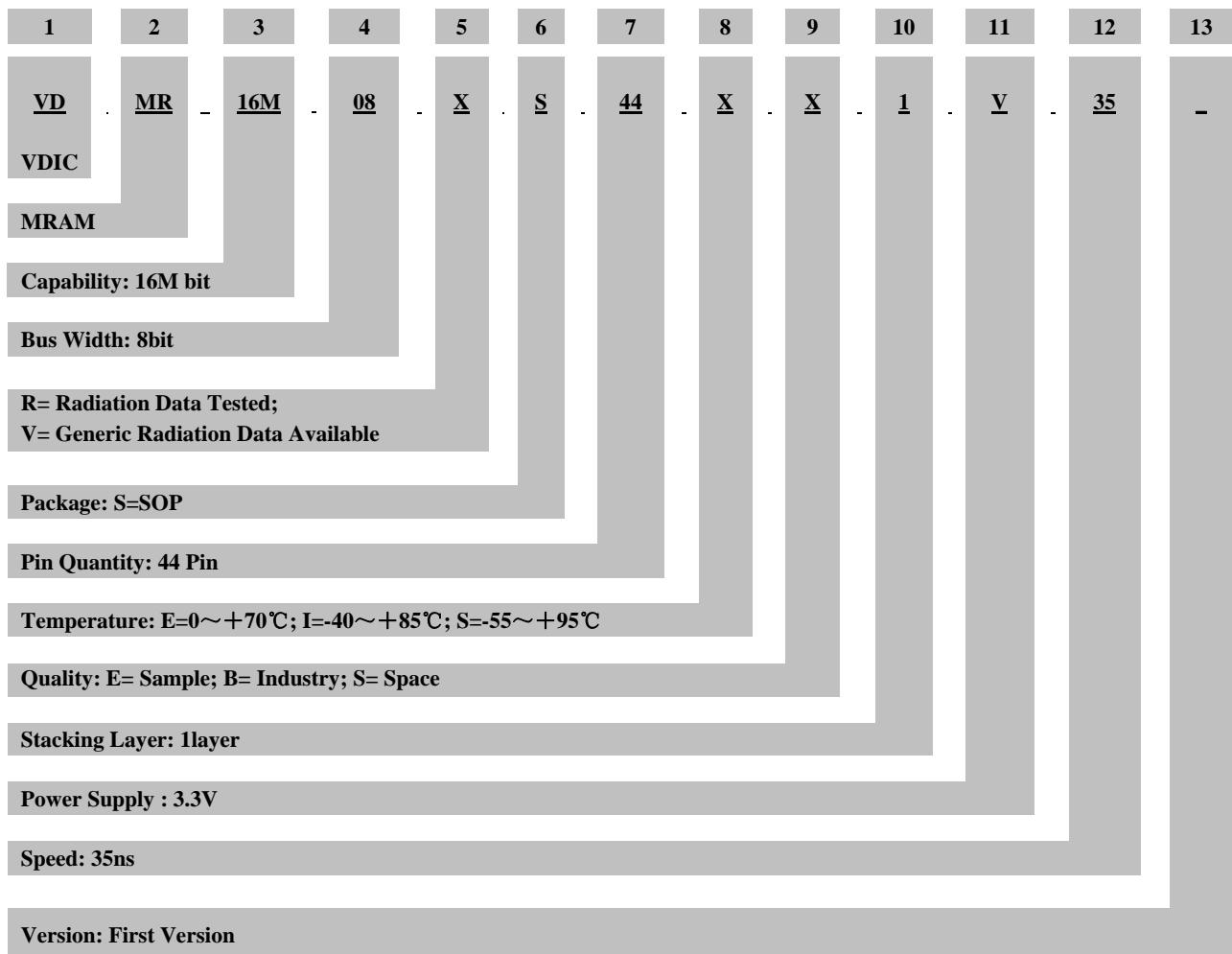


Table 5 Ordering information

| Part Number | Capacity (bit) | Bus Width (bit) | Radiation | | | Packaging | Temperature (°C) |
|---------------------|-------------------|-----------------------|------------------|------------------|------------------|-----------|-----------------------|
| | | | TID ¹ | SEL ² | SEU ³ | | |
| VDMR16M08VS44EE1V35 | 16M | 8 | - | - | - | SOP44 | 0 ~ + 70 |
| VDMR16M08VS44IB1V35 | 16M | 8 | - | - | - | SOP44 | -40 ~ + 85 |
| VDMR16M08RS44SS1V35 | 16M | 8 | > 50 | > 75 | > 15 | SOP44 | -55 ~ + 95 |

¹ TID: Total Dose (Krad(Si))

² SEL: LET Threshold (Mev.cm²/mg)

³ SEU: SEU Threshold (Mev.cm²/mg)

8 PACKAGE DIMENSIONS

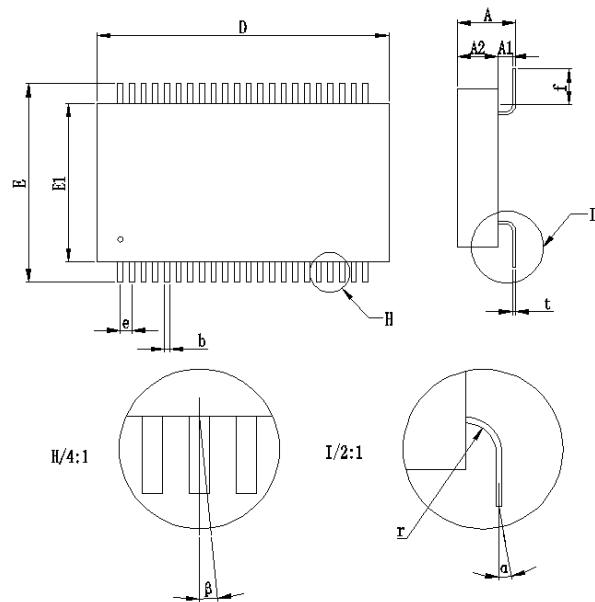


Figure 4 Package dimensions

Table 6 Dimensions information

| | Min | Max |
|----------|-------|----------------|
| A | 3.70 | 4.40 |
| A2 | 2.50 | 3.10 |
| D | 19.80 | 20.20 |
| E | 13.40 | 13.80 |
| E1 | 10.80 | 11.20 |
| f | | 2.00 |
| b | | 0.35 |
| e | | 0.80 |
| r | | 1.00 |
| t | | 0.20 |
| α | | $\leq 3^\circ$ |
| β | | $\leq 3^\circ$ |

NOTE: 1. Unit: mm
2. A1=A - A2

9 REVISION HISTORY

Table 7 Revision history

| Revision | Date | Description of Change |
|-----------------|--------------|---|
| A0 | Nov 1,2017 | First Created |
| A1 | May 22, 2018 | Modified Operating Temperature Range and Storage temperature. |
| A2 | Mar 21,2020 | Update TID and SEE |